PLE-52F DATA SHEET v1.6



BLE MODULE PLE-52F

PLE-52F module is a BLE module based on BT 5.0. It was developed using Nordic's nRF52840 chipset.



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Revision History

No	Version	Date	Page	Description
1	0.1	2019-05-09	All	First release
2	1.0	2019-05-14	1	Edit introduction
3	1.0	2019-05-14	8-16	Edit module schematic and schematic options
4	1.1	2019-05-21	13-16	Edit circuit configurations
5	1.2	2019-06-27	8	Edit Module Schematic
6	1.3	2019-07-16	5,6p	Edit Module pin numbers (P0.14, P0.15)
7	1.4	2020-01-31	5р	Edit Module pin numbers (P1.08, P1.09, P1.23, P1.01, P1.03, P1.05, P1.07, P1.02, P1.04, P1.06)
8	1.5	2020-04-03	18p	Add certification
9	1.6	2020-04-23	17p	Edit Antenna Performance image







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1. Introduction



PLE-52F

The PLE-52F module was developed using Nordic Semiconductor's <u>nRF52840 QIAA</u>.

The <u>nRF52840 SoC</u> is the most advanced member of the nRF52 Series SoC family. It meets the challenges of sophisticated applications that need protocol concurrency and a rich and varied set of peripherals and features. It offers generous memory availability for both Flash and RAM, which are prerequisites for such demanding applications.

The nRF52840 is built around the 32-bit ARM[®] Cortex[™]-M4 CPU with floating point unit running at 64 MHz. It has NFC-A Tag for use in simplified pairing and payment solutions. The ARM TrustZone[®] CryptoCell cryptographic unit is included on-chip and brings an extensive range of cryptographic options that execute highly efficiently independent of the CPU. It has numerous digital peripherals and interfaces such as high speed SPI and QSPI for interfacing to external flash and displays, PDM and I2S for digital microphones and audio, and a full speed USB device for data transfer and power supply for battery recharging.

Exceptionally low energy consumption is achieved using a sophisticated on-chip adaptive power management system.

1.1 Applications

- IoT
- Smart Home products

- Interactive entertainment devices
- Advanced remote controls

- Industrial mesh networks
- Smart city infrastructure
- Advanced wearables
- Connected watches
- Advanced personal fitness devices
- Wearables with wireless payment
- Connected Health
- Virtual/Augmented Reality applications

- Gaming controller





2. Specifications

2.1 Module Block Diagram

F	PLE-52F	[:] modu	le			
	nRF5284()-QIAA				
	64MHz AR	.M®	1MB Flash with Cache		Multi-Protocol	
	Cortex®-M4F 256kB RAM			2.4GHz Radio	Antenna	
-	System Peripherals			A	NFC-A Tag	
	Crypto Co-P	roc	DEBUG	3/AP	Oscillators	
	5×TIMER	3×RTC	WDT	32MHz RC/XO		32MHz Crystal
	Digital, Analog	g I/F and IO P	orts			
l l	2×UART	3×SPI	2×I2C	A/PF	Power Supply	
ſ	PDM	LI2S	QDEC	, A	LDO	
ľ	2×ACMP	4×PWM	12-bit ADC		2-stage Buck DC/DC	GPIO x 48
l L L	USB	QSPI	HS-SPI		POR BOD	
	4	8-GPIO Crossb	bar		VBUS 3.3V reg	i



PLE-52F MODULE BLOCK DIAGRAM



2.2 Chipset Specifications (nRF52840)

Frequency band	2.4GHz
On-air data rate	2Mbs/1Mbs/500kbs/125kbs - Bluetooth low energy 250kbs - 80215.4
	20kbs - 002.10.4 2Mbs /1Mbs - 2/GHz proprietany
Output power	Programmable -20dBm to +8dBm
Sansitivity	Plusteeth 5: 102dPm at 125kbs 00dPm at
Sensitivity	500kbs, -96dBm at 1Mbs, -92dBm at 2Mbs
	ANT: -92 5dBm at 1Mbs
	2.4GHz: -92.5dBm at 1Mbs, -89dBm at 2Mbs
Radio current con-	4.8mA TX at 0dBm, DC/DC at 3V
sumption DC-DC	14.8mA TX at +8dBm, DC/DC at 3V
at sv	9.6mA TX at +4dBm, DC/DC at 3V
	4.6mA RX at 1Mbps
Microcontroller	ARM Cortex-M4F
Program memory	1MB Flash with cache
RAM	256kB
Oscillators	32MHz crystal oscillator, 64MHz RC oscil- lator, 32kHz crystal oscillator, 32kHz RC oscillator
System current consumption	0.5µA at 3V System OFF mode, no RAM retention
	1.5µA System ON mode, no RAM retention
	0.7µA All peripherals in IDLE mode
	0.03µA per 4kB RAM retention
Hardware security	128-bit AES ECB/CCM/AAR co-processor
Cryptography	ARM CryptoCell 310
GPIO	48 configurable
Digital I/O	QSPI x 1, SPI master x 3, SPI slave x 3, 2-wire master x 2, 2-wire slave, UARTE x 2, Quadrature decoder, PDM, I ² S
Peripherals	12-bit/200ksps ADC, RNG, LP comparator, WDT, PWM x 4
PPI	20
USB	USB 2.0 (12Mbs)
Power supply	LDO, DC-DC
Timers/counters	32-bit timers x 5, RTC x 3
Package options	AQFN73, 7×7mm
NFC	NFC-A



3. Layout

3.1 Dimensions



PLE-52F MODULE DIMENSIONS









3.1.1 Pin assignment

(For details, see the	nRF52840	datasheet.
-		-

Pin	Name	Description	Pin	Name	Description
1	GND		32	P0.15	
2	P1.11		33	P0.16	
3	P1.13	Standard drive, low frequency I/O only.	34	P0.17	
4	P1.15	Standard drive, low frequency I/O only.	35	P0.18 / RESET	QSPI / CSN
5	P0.02 / AIN0	Standard drive, low frequency I/O only.	36	P0.22	QSPI
6	P0.03 / AIN1	Standard drive, low frequency I/O only.	37	P0.24	
7	P0.29 / AIN5	Standard drive, low frequency I/O only.	38	P0.25	
8	P0.31 / AIN7	Standard drive, low frequency I/O only.	39	SWDIO	
9	DEC4_6		40	SWDCLK	
10	DCC		41	P0.10	Standard drive, low frequency I/O only.
11	P0.00 / XL1		42	P0.09	Standard drive, low frequency I/O only.
12	P0.01 / XL2		43	GND	
13	P0.26		44	P1.10	
14	P0.27		45	P1.12	Standard drive, low frequency I/O only.
15	P0.05 / AIN3		46	P1.14	Standard drive, low frequency I/O only.



Pin	Name	Description	Pin	Name	Description
16	GND		47	P0.28 / AIN4	Standard drive, low frequency I/O only.
17	P0.04 / AIN2	Standard drive, low frequency I/O only.	48	P0.30 / AIN6	Standard drive, low frequency I/O only.
18	P0.06		49	P1.09	
19	P0.07		50	P1.08	
20	P0.08		51	P0.20	
21	P0.12		52	P0.19	QSPI / SCK
22	P0.11	Standard drive, low frequency I/O only.	53	P0.21	QSPI
23	VDD		54	P1.00	QSPI
24	DCCH		55	P1.06	Standard drive, low frequency I/O only.
25	VDDH		56	P1.04	Standard drive, low frequency I/O only.
26	D+	USB	57	P1.02	Standard drive, low frequency I/O only.
27	D-	USB	58	P1.07	Standard drive, low frequency I/O only.
28	VBUS		59	P1.05	Standard drive, low frequency I/O only.
29	DECUSB		60	P1.03	Standard drive, low frequency I/O only.
30	P0.13		61	P1.01	Standard drive, low frequency I/O only.
31	P0.14		62	P0.23	QSPI





3.2 Recommended PCB guide



PLE-52F PCB FOOTPRINT

[unit : mm]







3.3 Module Schematic (PLE-52F)



PLE-52F SCHEMATIC





3.4 Schematic options

3.4.1 32.768kHz external crystal (optional)

Internal or external crystal can be set in F / W. (For details, see the <u>nRF52840 datasheet</u>.)









3.4.2 Circuit configurations

Some general guidance is summarized here:

(For details, see the nRF52840 datasheet.)

- External supply from VDD is only available when power is supplied to VDDH. External supply is annotated with the VEXT net name.
- When supplying power from a USB source only, VBUS must be connected to VDDH if USB is to be used.
- Components required for DC/DC function are only needed if DC/DC mode is enabled for that regulator.
- NFC can be used in any configuration.
- USB can be used in any configuration as long as VBUS is supplied by the USB host.
- The schematics include an optional series resistor on the USB supply for improved immunity to transient overvoltage during VBUS connection. Using the series resistor is recommended for new designs.
- Two component values for the RF-Match network for the QIAA aQFN™73 package are given and referred to as v1.0 and v1.1 in the following tables. The reference schematics use v1.1 component values, which are recommended for new designs to improve the margin for spurious emissions during regulatory approval tests. However, both v1.0 and v1.1 are valid and can be used. All other RF parameters are unchanged.

circuit coningu							
Config no.	Supply configu	ration	Features that example	can be enabled	l for each confi	iguration	I
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC
Config. 1	USB (VDDH = VBUS)	N/A	Yes	No	No	Yes	No

Circuit configurations for QIAA aQFN™73

Config. 2	Battery/Ext. regulator	N/A	Yes	No	No	Yes	No
Config. 3	N/A	Battery/Ext. regulator	No	No	No	Yes	No
Config. 4	Battery/Ext. regulator	N/A	Yes	Yes	Yes	Yes	No
Config. 5	N/A	Battery/Ext. regulator	No	No	Yes	Yes	Yes
Config. 6	N/A	Battery/Ext. regulator	No	No	No	No	No

CIRCUIT CONFIGURATIONS



Config no.	Supply configura	ition	Enabled featu	res			
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC
Config. 1	USB (VDDH = VBUS)	N/A	Yes	No	No	Yes	No





Config no.	Supply configur	ation	Enabled featu	ures				
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC	
Config. 2	Battery/Ext. regulator	N/A	Yes	No	No	Yes	No	





Config no.	Supply configura	ation	Enabled featu	ures				
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC	
Config. 3	N/A	Battery/Ext. regulator	No	No	No	Yes	No	





Config no.	Supply configuration Enabled features VDDH VDD EXTSUPPLY DCDCEN0 DC Battery/Ext. N/A Yes Yes Yes regulator Yes Yes Yes Yes						
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC
Config. 4	Battery/Ext. regulator	N/A	Yes	Yes	Yes	Yes	No





Config no.	onfig no. Supply configuration		Enabled features				
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC
Config. 5	N/A	Battery/Ext. regulator	No	No	Yes	Yes	Yes







Config no.	ifig no. Supply configuration		Enabled features				
	VDDH	VDD	EXTSUPPLY	DCDCEN0	DCDCEN1	USB	NFC
Config. 6	N/A	Battery/Ext. regulator	Νο	No	Νο	No	No







4. Antenna







5. Certification

5.1 KC

71AF-01F3-B9A4-334B

Registration	of Broadcasting and Communication Equipments
상호 또는 성명 Trade Name or Registrant	주식회사 엘테크
기자재명칭(제품명칭) Equipment Name	특정소출력 무선기기(무선데이터통신시스템용 무선기기)
기본모델명 Basic Model Number	PLE-52F
파생모.델명 Series Model Number	PLE-52FM
등록번호 Registration No.	R-R-pro-B02
제조자/제조(조립)국가 Manufacturer/Country of Origin	주식회사 엘테크 / 한국
등록연월일 Date of Registration	2019-08-29
기타	



